UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/510,389	12/14/2004	Nobuo Ishii	101248.55500US	6492
23911 CROWELL & I	7590 03/08/2007 MORING LLP	EXAMINER		
INTELLECTUAL PROPERTY GROUP			DHINGRA, RAKESH KUMAR	
P.O. BOX 14300 WASHINGTON, DC 20044-4300			ART UNIT	PAPER NUMBER
	,		1763	
				
SHORTENED STATUTORY	Y PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE	
3 MOR	NTHS	03/08/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

	Application No.	Applicant(s)			
	10/510,389	ISHII, NOBUO			
Office Action Summary	Examiner	Art Unit			
	Rakesh K. Dhingra	1763			
The MAILING DATE of this communication a Period for Reply	ppears on the cover sheet with	n the correspondence address			
A SHORTENED STATUTORY PERIOD FOR REP WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory perions. - Failure to reply within the set or extended period for reply will, by status Any reply received by the Office later than three months after the main earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATION OF THIS COMMUNICA	ATION. bly be timely filed HS from the mailing date of this communication. NDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 14	December 2004.	,			
2a) ☐ This action is FINAL . 2b) ☒ Th					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under	Ex parte Quayle, 1935 C.D.	11, 453 O.G. 213.			
Disposition of Claims		•			
4) Claim(s) 1-4 is/are pending in the application	ı. ·				
4a) Of the above claim(s) is/are withdr	rawn from consideration.				
5) Claim(s) is/are allowed.	,				
6)⊠ Claim(s) <u>1-4</u> is/are rejected.	•				
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and	or election requirement.				
Application Papers		•			
9) The specification is objected to by the Examin	ner.				
10)⊠ The drawing(s) filed on <u>07 October 2004</u> is/ai	re: a)⊠ accepted or b)⊡ obj	ected to by the Examiner.			
Applicant may not request that any objection to the	ne drawing(s) be held in abeyance	e. See 37 CFR 1.85(a).			
Replacement drawing sheet(s) including the corre		· · ·			
→1) The oath or declaration is objected to by the l	Examiner. Note the attached (Office Action or form PTO-152.			
Priority under 35 U.S.C. § 119	•				
12)⊠ Acknowledgment is made of a claim for foreig a)⊠ Áll b)□ Some * c)□ None of:	gn priority under 35 U.S.C. § 1	119(a)-(d) or (f).			
1. ☐ Certified copies of the priority docume	nts have been received				
2. Certified copies of the priority docume		plication No.			
3. ☐ Copies of the certified copies of the pr					
application from the International Bure	•				
* See the attached detailed Office action for a list	st of the certified copies not re	eceived.			
Attachment(s)					
1) Notice of References Cited (PTO-892)	4) Interview Su	mmary (PTO-413) Mail Date			
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08)		ormal Patent Application			
Paper No(s)/Mail Date <u>12/04, 02/05</u> .	6) 🔲 Other:	-			

Application/Control Number: 10/510,389

Art Unit: 1763

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ishii et al (US PGPUB No. 2002/0038692) in view of Suzuki et al (US Patent No. 6,652,709).

Regarding Claim 1: Ishii et al teach a plasma processing apparatus (Figures 1, 9, 14, 20) for effecting predetermined processing on a substrate by exposing the substrate to a plasma production region, comprising:

a chamber 11 in which the substrate 21 is introduced;

a top plate portion (dielectric plate 13) arranged above said substrate 21 introduced in said chamber, and forming a part of a wall of said chamber 11; and

an antenna portion 30 supplying a high-frequency electromagnetic field into said chamber to form the plasma production region in a region between said top plate portion 13 and said substrate 21 located in said chamber 11, wherein said antenna portion 30 includes a radial waveguide 36 having a predetermined inner diameter, said chamber 11 has a predetermined inner diameter in a portion containing said top plate portion 12 and said antenna portion 30 (paragraphs 0048-0058). Ishii et al also teach that by using formula 27 (paragraph 0144) it is possible to compute composite dielectric constant of the space portion containing the window and the slot antenna, if other variables like dielectric constant of top plate (window), dielectric constant of the space between window and antenna (air in this case),

Application/Control Number: 10/510,389

Art Unit: 1763

thickness of dielectric window and the gap between the window and the slot antenna are known (Figure 14 and paragraphs 0144-0146). Based on this composite dielectric constant, value of wavelength lambda.sub.g (given in the claim) can be calculated (by using formula lambda /dielectric constant).

Ishii et al teach inner diameter of the radial waveguide (Figure 9A), but do not teach relative dimensions of the inner diameter of radial waveguide and the portion containing top plate portion and the antenna portion.

Suzuki et al teach a plasma apparatus (Figures 6A, 6B) for controlling standing waves in a radial waveguide comprising a chamber 1 with a dielectric window 4 as top wall, a circular waveguide 13 with an antenna having slots 23. Suzuki et al also teach diameter of window (like dimension B in the claim for the top plate portion) 4 is 299 mm, and inner diameter of waveguide disc is (152-96) 56 mm (like dimension A in the claim) [column 11, line 30 to column 12, line 25]. It would be obvious to optimize the dimension of top plate portion in the apparatus of Ishii et al as per relative dimensions of radial waveguide and window (top plate portion) as taught by Suzuki, as per other related factors like dielectric constant of top plate (window), dielectric constant of the space between window and antenna (air in this case), thickness of dielectric window and the gap between the window and the slot antenna to enable control standing waves in the radial waveguide and to obtain plasma of high density with uniformity (column 3, lines 32-37).

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to optimize the dimensions of top portion and the radial waveguide in the apparatus of Ishii et al as taught by Suzuki, as per process limitations and other related factors like dielectric constant of top plate (window), dielectric constant of the space between window and antenna (air in this case), thickness of dielectric window and the gap between the window and the slot antenna, to enable control standing waves in the radial waveguide and to obtain plasma of high density with uniformity (column 3, lines 32-37).

Page 4

Application/Control Number: 10/510,389

Art Unit: 1763

Regarding Claim 2: Ishii et al teach that inner diameter of chamber 11 is less than inner diameter of radial

waveguide 36, that is claim formula C </= A, is satisfied (Figure 1).

Regarding Claims 3, 4: Admitted prior art teach that top plate portion 13 comprises a dielectric material

(paragraph 0049).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should

be directed to Rakesh K. Dhingra whose telephone number is (571)-272-5959. The examiner can

normally be reached on 8:30 -6:00 (Monday - Friday).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor,

Parviz Hassanzadeh can be reached on (571)-272-1435. The fax phone number for the organization

where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application

Information Retrieval (PAIR) system. Status information for published applications may be obtained

from either Private PAIR or Public PAIR. Status information for unpublished applications is available

through Private PAIR only. For more information about the PAIR system, see http://pair-

direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic

Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer

Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR

CANADA) or 571-272-1000.

Rakesh Dhingra

Parviz Hassanzadeh

Supervisory Patent Examiner

Art Unit 1763